NZX series



Product data sheet

1. **Product profile**

1.1 General description

General-purpose Zener diodes in a SOD27 (SC-40) small hermetically sealed glass package.

1.2 Features and benefits

- Total power dissipation: P_{tot} ≤ 500 mW
- Low differential resistance
- Low leakage current

1.3 Applications

General regulation functions

1.4 Quick reference data

Quick reference data

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{F}	forward voltage	$I_F = 200 \text{ mA}$	<u>[1]</u> -	-	1.5	V

^[1] Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

2. Pinning information

Table	2.	Pinning	

Pin	Description	Simplified outline	Graphic symbol
1	cathode	<u>[1]</u>	
2	anode	k	1 2 006aaa152

^[1] The marking band indicates the cathode.



3. Ordering information

Table 3. Ordering information

Type number	Package						
	Name	Description	Version				
NZX2V1B to NZX36X[1]	SC-40	hermetically sealed glass package; axial leaded; 2 leads	SOD27				

^[1] The series consists of 112 types with nominal working voltages from 2.1 V to 36 V.

4. Marking

Table 4. Marking codes

Type number	Marking code
NZX2V1B to NZX36X	the diodes are type branded

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

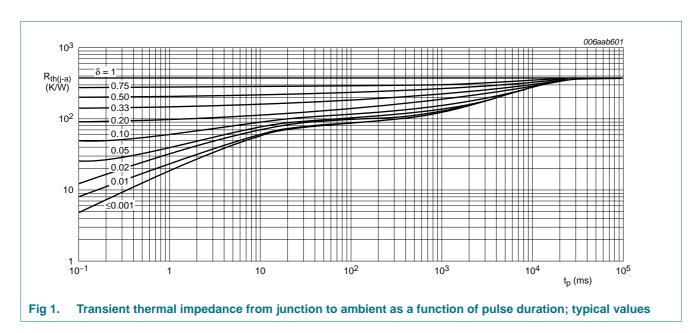
Symbol	Parameter	Conditions	Min	Max	Unit
I _F	forward current		-	250	mA
P _{tot}	total power dissipation	$T_{tp} \le 25 ^{\circ}C$	-	500	mW
T _j	junction temperature		-	175	°C
T _{amb}	ambient temperature		–55	+175	°C
T _{stg}	storage temperature		-65	+175	°C

6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] -	-	380	K/W
R _{th(j-t)}	thermal resistance from junction to tie-point		[1] -	-	300	K/W

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB) without metallization pad; maximum lead length 8 mm.



7. Characteristics

Table 7. Characteristics

 $T_i = 25 \, ^{\circ}\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F	forward voltage	$I_F = 200 \text{ mA}$	<u>[1]</u> -	-	1.5	V

^[1] Pulse test: $t_p \leq 300~\mu s; \, \delta \leq 0.02.$

Table 8. Characteristics per type; NZX2V1B to NZX18C

 $T_i = 25$ °C unless otherwise specified.

NZXxxx	Sel	Working vo V _Z (V)	ltage	Differential resistance $r_{dif}(\Omega)$	Reverse cui I _R (μA)	rent
		$I_Z = 5 \text{ mA}$		I _Z = 5 mA		
		Min	Max	Max	Max	V _R (V)
2V1	В	2.0	2.2	100	5	0.5
2V4	Α	2.3	2.5	100	50	1
	B 2.4 2.6					
2V7	Α	2.5	2.7	100	20	1
	В	2.6	2.8			
	С	2.7	2.9			
3V0	Α	2.8	3.0	100	10	1
	В	2.9	3.1			
	С	3.0	3.2			
3V3	Α	3.1	3.3	100	5	1
	В	3.2	3.4			
С	3.3	3.5				

Table 8. Characteristics per type; NZX2V1B to NZX18C ...continued $T_i = 25$ °C unless otherwise specified.

NZXxxx	Sel	Working vo	ltage	Differential resistance r _{dif} (Ω)	Reverse cui	rrent
		I _Z = 5 mA		I _Z = 5 mA		
		Min	Max	Max	Max	V _R (V)
3V6	Α	3.4	3.6	100	5	1
	В	3.5	3.7			
	С	3.6	3.8			
3V9	A	3.7	3.9	100	3	1
	В	3.8	4.0			
	С	3.9	4.1			
4V3	Α	4.0	4.2	100	3	1
	В	4.1	4.3			
	С	4.2	4.4			
	D	4.3	4.5			
4V7	Α	4.4	4.6	100	3	2
	В	4.5	4.7			
	С	4.6	4.8			
	D	4.7	4.9			
5V1	Α	4.8	5.0	100	2	2
	В	4.9	5.1			
	С	5.0	5.2			
	D	5.1	5.3			
5V6	Α	5.2	5.5	40	1	2
	В	5.3	5.6			
	С	5.4	5.7			
	D	5.5	5.8			
	E	5.6	5.9			
6V2	Α	5.7	6.0	15	3	4
	В	5.8	6.1			
	С	6.0	6.3			
	D	6.1	6.4			
	Е	6.3	6.6			
6V8	Α	6.4	6.7	15	2	4
	B 6.6 6.9	6.9				
	С	6.7	7.0			
	D	6.9	7.2			

Table 8. Characteristics per type; NZX2V1B to NZX18C ...continued $T_i = 25$ °C unless otherwise specified.

NZXxxx	Sel	Working V _Z (V)	voltage	Differential resistance	Reverse I _R (μA)	current	
		1 5 4		r _{dif} (Ω)			
		I _Z = 5 mA		$I_Z = 5 \text{ mA}$	N#	V OO	
, ,		Min	Max	Max	Max	V _R (V)	
7V5	A	7.0	7.3	15	1	5	
	В	7.2	7.6				
	С	7.3	7.7				
	D	7.5	7.9				
-> /-	X	7.07	7.45				
8V2	A	7.7	8.1	20	0.7	5	
	В	7.9	8.3				
	С	8.1	8.5				
	D	8.3	8.7				
9V1	Α	8.5	8.9	20	0.5	6	
	В	8.7	9.1				
	С	8.9	9.3				
	D	9.1	9.5				
	Е	9.3	9.7				
10	Α	9.5	9.9	25	0.2	7	
	В	9.7	10.1				
	С	9.9	10.3				
	D	10.2	10.6				
11	Α	10.4	10.8	25	0.1	0.1	8
	В	10.7	11.1				
	С	10.9	11.3				
	D	11.1	11.6				
12	Α	11.4	11.9	35	0.1	8	
	В	11.6	12.1				
	С	11.9	12.4				
	D	12.2	12.7				
	X	11.44	12.03				
13	Α	12.4	12.9	35	0.1	8	
	В	12.6	13.1				
	С	12.9	13.4				
14	Α	13.2	13.7	35	0.05	9.8	
	В	13.5	14.0				
	С	13.8	14.3				

Table 8. Characteristics per type; NZX2V1B to NZX18C ...continued

 $T_i = 25$ °C unless otherwise specified.

NZXxxx	Sel	Working voltage V _Z (V)		Differential resistance $r_{dif}(\Omega)$	Reverse current I _R (μA)		
		$I_Z = 5 \text{ mA}$		$I_Z = 5 \text{ mA}$			
		Min	Max	Max	Max	V _R (V)	
15	A 14.1 14.7 40	0.05	10.5				
	В	14.5	15.1				
	С	14.9	15.5				
	X	14.35	15.09				
16	Α	15.3	15.9	45	0.05	11.2	
	В	15.7	16.5				
	С	16.3	17.1				
18	Α	16.9	17.7	55	0.05	12.6	
	В	17.5	18.3				
	С	18.1	19.0				

Table 9. Characteristics per type; NZX20A to NZX36X $T_j = 25 \, ^{\circ}$ C unless otherwise specified. Table 9.

NZXxxx	Sel	Working voltage $V_{Z}\left(V\right)$ $I_{Z}=2\text{ mA}$		Differential resistance $r_{dif}(\Omega)$ $I_Z = 2 \text{ mA}$	Reverse current I _R (μA)	
		20	Α	18.8	19.7	60
В	19.5		20.4			
	С	20.2	21.2			
22	Α	20.9	21.9	65	0.05	15.4
	В	21.6	22.6			
	С	22.3	23.3			
24	Α	22.9	24.0	70	0.05	16.8
	В	23.6	24.7			
	С	24.3	25.5			
	X	22.61	23.77			
27	Α	25.2	26.6	80	0.05	18.9
	В	26.2	27.6			
	С	27.2	28.6			
	X	26.99	28.39			
30	Α	28.2	29.6	100	0.05 2	21
	В	29.2	30.6			
	С	30.2	31.6			
	X	29.02	30.51			
33	Α	31.2	32.6	120	0.05 23.1	23.1
	В	32.2	33.6			
	С	33.2	34.5			
36	Α	34.2	35.7	140	0.05	25.2
	В	35.3	36.8			
	С	36.4	38.0			
	Χ	35.36	37.19			

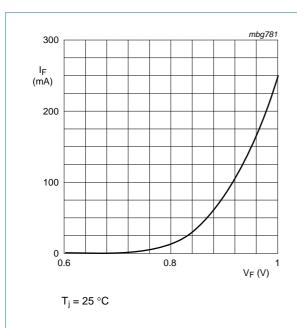
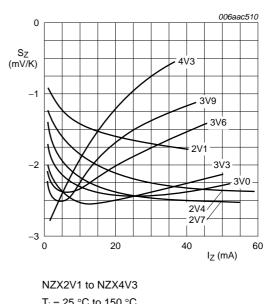
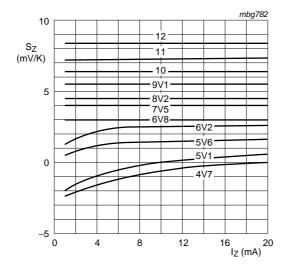


Fig 2. Forward current as a function of forward voltage; typical values



 $T_i = 25 \,^{\circ}\text{C}$ to 150 $^{\circ}\text{C}$

Fig 3. Temperature coefficient as a function of working current; typical values

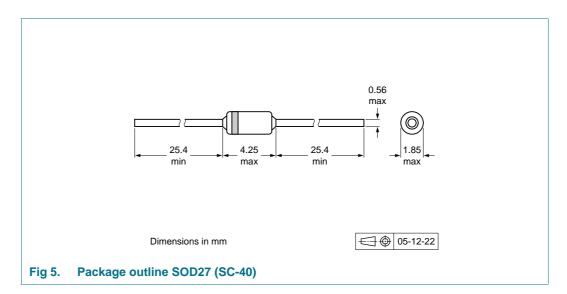


NZX4V7 to NZX12

 $T_i = 25 \,^{\circ}\text{C}$ to 150 $^{\circ}\text{C}$

Fig 4. Temperature coefficient as a function of working current; typical values

8. Package outline



9. Packing information

Table 10. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number[2]	Package	Description	Packing quantity	
			5000	10000
NZX2V1B to NZX36X	SOD27	26 mm tape ammopack, axial	-143	-
		52 mm tape ammopack, axial	-	-133
		52 mm reel pack, axial	-	-113

^[1] For further information and the availability of packing methods, see <u>Section 12</u>.

^[2] The series consists of 112 types with nominal working voltages from 2.1 V to 36 V.



10. Revision history

Table 11. Revision history

	•			
Document ID	Release date	Data sheet status	Change notice	Supersedes
NZX_SER v.4	20111128	Product data sheet	-	NZX_SER v.3
Modifications:	• <u>Section 1.2</u> :	corrected.		
	 Section 11 "L 	<u>egal information"</u> : updated		
NZX_SER v.3	20110121	Product data sheet	-	NZX_SER v.2
NZX_SER v.2	20090603	Product data sheet	-	NZX_SER v.1
NZX_SER v.1	20080724	Product data sheet	-	-

11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

11.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

11.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or

malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

NZX_SER

NXP Semiconductors NZX series

Single Zener diodes

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the

product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

11.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

12. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com



13. Contents

1	Product profile
1.1	General description 1
1.2	Features and benefits1
1.3	Applications
1.4	Quick reference data 1
2	Pinning information 1
3	Ordering information 2
4	Marking 2
5	Limiting values
6	Thermal characteristics 2
7	Characteristics 3
8	Package outline 9
9	Packing information 9
10	Revision history 10
11	Legal information
11.1	Data sheet status
11.2	Definitions
11.3	Disclaimers
11.4	Trademarks
12	Contact information 12
13	Contents

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов:
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001:
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина,

дом 2, корпус 4, литера А.